



# Product Change Notification

**Change Notification #: 117010 - 00**

**Change Title: Intel® Server System R2308WFTZSR,  
Intel® Server System R2312WFTZSR,  
PCN 117010-00, Product Design,  
Update BIOS/BMC/ME/FRUSDR Firmware**

**Date of Publication: June 18, 2019**

## Key Characteristics of the Change:

Product Design

## Forecasted Key Milestones:

<b>Date Customer Must be Ready to Receive Post-Conversion Material: *</b>	July 3, 2019
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\*Intel appreciates the customer's desire to receive the latest revision of products. However, Intel manages inventory on a first in first out (FIFO) basis at the MM# level. Subsequently, customer requests for a specific revision of material (below the MM#) will not be supported by Intel

## Description of Change to the Customer:

Intel is implementing the following changes on the Intel® Server Systems listed in the "Products Affected" table below:

1. Update BIOS revision to R02.01.0008
2. Update the Manageability Engine (ME) firmware revision to 04.01.04.251
3. Update the Baseboard Management Controller (BMC) firmware revision to 1.93.870cf4f0
4. Update the FRUSDR revision to 1.93

## Customer Impact of Change and Recommended Action:

Intel does not expect any impact to customers from these changes, but encourages customers to understand the change and determine the impact on their applications. For that reason Intel recommends that the customer perform a standard level of evaluation. Customers can download and evaluate the latest BIOS/ME/Integrated BMC and FRUSDR release notes for more information at <https://www.intel.com/support/>.

Intel does not expect any impact to customers from these changes, but encourages customers to understand the change and determine the impact on their applications.

**Products Affected / Intel Ordering Codes:**

Product Code	MM#	Pre Change TA	Pre Change PBA	Post Change TA	Post Change PBA
R2308WFTZSR	986052	K40014-001	H48104-871 H48104-881	K40014-002	H48104-872 H48104-882
R2312WFTZSR	986053	K40015-001	H48104-871 H48104-881	K40015-002	H48104-872 H48104-882

**PCN Revision History:****Date of Revision:**

June 18, 2019

**Revision Number:**

00

**Reason:**

Originally Published PCN



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**Should you have any issues with the timeline or content of this change, please contact the Intel Representative(s) for your geographic location listed below. No response from customers will be deemed as acceptance of the change and the change will be implemented pursuant to the key milestones set forth in this attached PCN.**

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